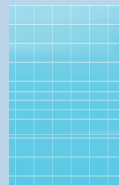


**January 9–13, 2010**  
**Las Vegas, USA**  
<http://www.icce.org>

**IEEE CONSUMER ELECTRONICS SOCIETY**

# CALL FOR PAPERS



## CO-LOCATED WITH THE INTERNATIONAL CONSUMER ELECTRONICS SHOW

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## 28TH INTERNATIONAL CONFERENCE ON CONSUMER ELECTRONICS 2010



### Conference Theme: Green Consumer Electronics Technologies

The International Conference on Consumer Electronics (ICCE) is soliciting technical papers for oral and poster presentation at ICCE 2010. Now in its 28th year, ICCE has a strong conference history coupled with a tradition of attracting leading authors and delegates from around the world. Papers reporting new developments in all areas of consumer electronics are invited, including but not limited to those listed below. Student papers and papers of a tutorial nature are particularly encouraged. This year, papers relating to Green Consumer Electronic Technologies are particularly sought for a special session.

Tutorials are scheduled during the Conference. Brief proposals should be submitted by June 1st, to Atul Batra at [abatra@marvell.com](mailto:abatra@marvell.com). Proposals must include title, abstract, detailed outline, as well as bio and contact information for the presenter.

### TOPICS

#### HOME ENTERTAINMENT

Home Gateway, DTV, Home Theater, PVR, Interconnects, Game Systems, Interactive and Directed Programming, Internet Integration, Advanced DVD and CD, Displays

#### MOBILE COMPUTING & COMMUNICATION

Mobile Broadband, Handheld & Wearable Computers, Personal Multimedia Devices, Next Generation Cellular, AV Streaming to Handheld Devices

#### A/V TECHNOLOGY

Still & Video Cameras, Analog and Digital Audio, 3D Video, Recording, Storage, Compression, Transcoding, Applied Signal Processing, Content Indexing, Networked A/V, Video Enhancement, Visual Quality Assessment, Emerging VOD and Non-Real-Time (NRT) Services & Standards

#### RF & WIRELESS

Antennas, Acquisition, Equalization, Spectrum Usage, Software Radio, Wireless LAN, 802.11 Standards, Bluetooth, RFID, WPAN

#### CONSUMER NETWORKS

Wired & Wireless Multimedia, QoS, Security, Peer-to-Peer, Internet Appliances, Home Control, Bridges, Interoperability, Application Control, Home Architecture, Healthcare Applications and Energy Management.

#### AUTOMOTIVE ENTERTAINMENT & INFORMATION

Navigation, A/V Systems, Driver Assistance, Networks, Communication Aspects, Sensors and Control

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## AUTHOR'S INFORMATION

Deadline for Paper Submissions  
June 19, 2009

Notification of Acceptance  
September 7, 2009

Camera-Ready Paper Due  
October 2, 2009

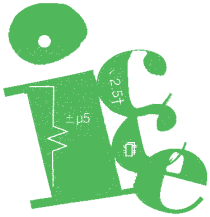
Authors are invited to submit a 2-page summary according to the posted submission guidelines. Only electronic submissions will be accepted via the web at <http://www.icce.org>.

At least one author of each paper MUST pre-register for the conference by October 16, 2009 for papers to be included in the program.

# IEEE CONSUMER ELECTRONICS SOCIETY CALL FOR PAPERS

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| Amine Bermak<br>Hong Kong University of<br>Science and Technology<br>eebermak@ust.hk            | David C. Hutchison<br>Texas Instruments<br>hutch@ti.com                                      | Saurabh Mathur<br>Thomson Inc.<br>saurabh.mathur@thomson.net                                 | Sorin G. Stan<br>TNO Science and Industry<br>/ Business Unit Automotive<br>sorin.stan@tno.nl |
| Petronel Bigjoi<br>Tessera Technologies<br>pbigjoi@tessera.com                                  | Takuya Ima-ide<br>Hitachi Ltd.<br>takuya.imaide.rz@hitachi.com                               | Dhawal B. Moghe<br>CableLabs<br>d.moghe@cablelabs.com  | Thanh Tran<br>Texas Instruments Inc<br>than.tran@ti.com                                      |
| Martin Bolton<br>STMicroelectronics<br>martin.bolton@st.com                                     | Michael A. Isnardi<br>Sarnoff Corporation<br>misanardi@sarnoff.com                           | Reinhard Moeller<br>University of Wuppertal<br>r.moeller@computer.org                        | Min-Jen Tsai<br>National Chiao Tung University<br>mjtsai@cc.nctu.edu.tw                      |
| George Rome Borden IV<br>Logitech, Inc<br>George_Borden@logitech.com                            | Fumio Isshiki<br>Hitachi, Ltd.<br>fumio.isshiki.qz@hitachi.com                               | Dhawal B. Moghe<br>Alcatel-Lucent<br>dhawal.moghe@alcatel-lucent.com                         | Peter van Beek<br>Sharp Laboratories of America<br>pvanbeek@sharplabs.com                    |
| Jill Boyce<br>Thomson<br>jill.boyce@thomson.net   | Ralph Justus<br>Consultant<br>rjustus@ieee.org   | Aldo W. Morales<br>Penn State Harrisburg<br>awm2@psu.edu                                     | Richard Verhoeven<br>Eindhoven University of Technology<br>p.h.f.m.verhoeven@tue.nl          |
| Yung-Chang Chen<br>National Tsing Hua University<br>ycchen@ee.nthu.edu.tw                       | Hari Kalva<br>Florida Atlantic University<br>hari@cse.fau.edu                                | Stefan Mozar<br>University of Western Sydney Australia<br>s.mozar@ieee.org                   | Anthony Vetro<br>Mitsubishi Electric Research Labs<br>avetro@merl.com                        |
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| Peter Corcoran<br>National University of Ireland, Galway<br>peter.corcoran@nuigalway.ie         | Brent Karley<br>Freescale Semiconductor<br>brent.karley@freescale.com                        | Wolfgang Mueller<br>University of Education Weingarten<br>mueller@md-phw.de                  | Xianbin Wang<br>The University of Western Ontario<br>wang@eng.uwo.ca                         |
| Thomas M. Coughlin<br>Coughlin Associates<br>tom@tomcoughlin.com                                | Nasser Kehtranavaz<br>University of Texas<br>kehtar@utdallas.edu                             | Antonio Navarro<br>University of Aveiro<br>navarro@av.it.pt                                  | Andreas Weber<br>University of Bonn<br>weber@cs.uni-bonn.de                                  |
| Yimin Dai<br>University of Science and<br>Technology of China (USTC)<br>daiym@ustc.edu.cn       | S. K. (Suki) Kim<br>Korea University<br>skkim@mail.korea.ac.kr                               | Marina Nicolas<br>ST Microelectronics<br>marina.nicolas@st.com                               | Wolfgang Weltersbach<br>NXP Semiconductors<br>Wolfgang.Weltersbach@nxp.com                   |
| Philip Dang<br>STMicroelectronics, Inc.<br>philip.dang@st.com                                   | Ihor Kirenko<br>Philips Research Laboratories<br>ihor.kirenko@philips.com                    | Anthony Ojo<br>NXP Semiconductors<br>anthony.ojo@nxp.com                                     | James Williamson<br>Sony Electronics, Inc.<br>James.Williamson@am.sony.com                   |
| Jayant Datta<br>Discrete Laboratories, Inc.<br>jayant_datta@hotmail.com                         | Sung-Jea Ko<br>Korea University<br>sjko@dali.korea.ac.kr                                     | Jose J. Pazos-Arias<br>University of Vigo<br>jose@det.uvigo.es                               | Tao Wu<br>Nokia<br>tao.a.wu@nokia.com  |
| Peter H. N. de With<br>CyCloMedia/Eindhoven<br>University of Technology<br>P.H.N.de.With@tue.nl | Uwe E. Kraus<br>University of Wuppertal<br>krausue@uni-wuppertal.de                          | Sharon Peng<br>Harman Consumer Group<br>speng@harman.com                                     | Hao Xin<br>University of Arizona<br>hxin@ece.arizona.edu                                     |
| Richard F. Doherty<br>Envisioneering<br>rdoherty@envisioneering.net                             | Akiomi Kunisa<br>SANYO Electric Co., Ltd.<br>kunisa@gf.hm.rd.sanyo.co.jp                     | Fernando Pescador<br>Polytechnic University of<br>Madrid, Spain<br>pescador@sec.upm.es       | Jun Xin<br>Xilient Inc.<br>jun.xin@xilient.comp  |
| Onno Eerenberg<br>NXP Semiconductors<br>onno.eerenberg@nxp.com                                  | Fredric Lindstrom<br>Limes Technology<br>fli@bth.se  | Igor Radovanovic<br>Eindhoven University of Technology<br>i.radovanovic@tue.nl               | Chojuro Yamamitsu<br>Pioneer Corporation<br>chojuro_yamamitsu@post.pioneer.co.jp             |
| Lee Estrada<br>Toshiba<br>lee.estrada@taec.toshiba.com  | Scott Linfoot<br>De Montfort University<br>sllinfoot@dmu.ac.uk                               | Albrecht Rothermel<br>University of Ulm<br>info@albrecht-rothermel.de                        | Kei Yamashita<br>Hitachi, Ltd.<br>kei.yamashita.ny@hitachi.com                               |
| James O. Farmer<br>Enablence Technologies<br>j.farmer@ieee.org                                  | Nam Ling<br>Santa Clara University<br>nling@scu.edu  | William A. Rowe<br>WARowe Consultancy<br>warowe@aol.com                                      | Xiaoquan (Bill) Yi<br>Google Inc.<br>byi@google.com  |
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